9/23 PA:		Atty Docket #: ONS00711
7/WP PAI	103092401	
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1. Name of conveying part(ies):	2. Name and address of receiving	ng party(ies):
Gordon M. Grivna Prasad Venkatraman	NAME: SEMICONDUCTOR COMPONENT Internal Address: Law Departmen	
Additional name(s) of conveying party(ies) is provided on attached shee	1.2	*
3. Nature of conveyance/Execution Date(s): Execution Date(s) September 15, 2005	Street Address: 5005 East McDow	vell Road
	City: Phoenix	
Security Agreement Change of Name	State: Arizona	
Joint Research Agreement	Country: USA Zip:	85008
Government Interest Assignment		
Executive Order 9424, Confirmatiory License	ļ	
Other	Additional name(s) & address(es) attached	? Yes ☐ No [
4. Application number(s) or patent number(s):A. Patent Application No.(s):	B. Patent No.(s):	a new application.
A. Patent Application No.(s): Additional numbers attached?	B. Patent No.(s):	
A. Patent Application No.(s):	B. Patent No.(s): Tes No 6. Total number of applications and pat	ents involved: 1
A. Patent Application No.(s): Additional numbers attached? 5. Name and address of party to whom correspondence concerning document should be mailed: Name: SEMICONDUCTOR COMPONENTS INDUSTRIES, L.L.C.	B. Patent No.(s):	ents involved: 1
A. Patent Application No.(s): Additional numbers attached? 5. Name and address of party to whom correspondence concerning document should be mailed: Name: SEMICONDUCTOR COMPONENTS INDUSTRIES, L.L.C. Internal Address: Patent Administration – A700	B. Patent No.(s): Yes No 6. Total number of applications and pat 7. Total fee (37 C.F.R. 3.41)	ents involved: <u>1</u>
A. Patent Application No.(s): Additional numbers attached? 5. Name and address of party to whom correspondence concerning document should be mailed: Name: SEMICONDUCTOR COMPONENTS INDUSTRIES, L.L.C. Internal Address: Patent Administration – A700 Street Address: P. O. Box 62890	B. Patent No.(s): Yes No 6. Total number of applications and pat 7. Total fee (37 C.F.R. 3.41)	ents involved: <u>1</u>
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A. Patent Application No.(s): Additional numbers attached? 5. Name and address of party to whom correspondence concerning document should be mailed: Name: SEMICONDUCTOR COMPONENTS INDUSTRIES, L.L.C. Internal Address: Patent Administration – A700 Street Address: P. O. Box 62890 City, State, Zip: Phoenix. Arizona 85082-2890 Phone Number: 602-244-4885 Fax Number: 602-244-3169/602-244-5601 Email Address: kevin.jackson@onsemi.com 9. Signature. Kevin B. Jackson Name of Person Signing	B. Patent No.(s): Yes No 6. Total number of applications and pat 7. Total fee (37 C.F.R. 3.41)	ents involved: 1 account in Jackson September 20, 200 Date
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Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to: Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, V.A. 22313-1450

ASSIGNMENT & AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, we,

Name Gordon M. Grivna Prasad Venkatraman of (City/State/Country) Mesa, Arizona, USA Gilbert, Arizona, USA

have sold, assigned, and transferred, and do hereby sell, assign, and transfer unto Semiconductor Components Industries, LLC (SCI), a limited liability Company of the State of Delaware, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives, the entire right, title, and interest in and to certain inventions relating to improvements in

METHOD OF FORMING A LOW RESISTANCE SEMICONDUCTOR CONTACT AND STRUCTURE THEREFOR Attorney Docket No.ONS00711

described, illustrated, and claimed in an application for Letters Patent of the United States of America executed by us, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation, or reissue thereof.

We hereby also sell, assign, and transfer unto SCI, the entire right, title, and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the inventions and the applications for Letters Patent in foreign countries, and we further authorize SCI to apply for Letters Patent in foreign countries directly in its own name, and to claim the priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation, or reissue, to SCI, for the sole use and behalf of SCI, its successors, assigns, and legal representatives, to the full end of the term for which the Letters Patent may be granted, the same as they would have been held and enjoyed by us had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to SCI.

We agree that, when requested, we will, without charge to SCI, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in SCI, its successors, assigns, and legal representatives or nominees.

We covenant with SCI, its successors, assigns, and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license, or other encumbrance.

STATE OF ARIZONA

SS.:

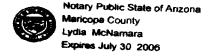
COUNTY OF MARICOPA)

I<u>, Lydia McNamara,</u> a Notary Public in and for the County and State aforesaid, do hereby certify that **Gordon** M. Grivna and Prasad Venkatraman, whose name(s) are subscribed to the foregoing instrument, appeared before me this day in person and acknowledged that they/he/she signed, sealed and delivered the instrument as their/his/her free and voluntary act and deed for the uses and purposes therein set forth.

Given under my hand and notarial seal this 154 day of September, 2005.

RECORDED: 09/23/2005

Lyplea In Chamera y commission expires on: July 30, 2006



PATENT REEL: 017031 FRAME: 0023